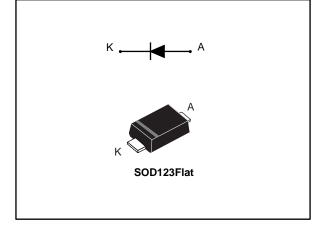


STPS2L40ZFY

Automotive low drop power Schottky rectifier

Datasheet - production data



Features



- AEC-Q101 qualified
- Very small conduction losses
- Negligible switching losses
- Low forward voltage drop
- Surface mount miniature packages
- Avalanche capability specified
- PPAP capable

Description

Single chip Schottky rectifiers suited to switched mode power supplies and high frequency DC to DC converters.

Packaged in SOD123Flat, this device is especially intended for surface mounting and used in low voltage, high frequency inverters, free-wheeling and polarity protection in automotive applications.

Table 1	:	Device	summary

Symbol	Value
lf(AV)	2 A
Vrrm	40 V
V _F (typ.)	0.50 V
T _i (max.)	175 °C

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This is information on a product in full production.

1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit	
Vrrm	Repetitive peak reverse voltage $T_j = -40 \text{ °C to } +175 \text{ °C}$		40	V
IF(AV)	Average forward current δ = 0.5, square wave	T _L = 145 °C	2	А
IFSM	Surge non repetitive forward current t _p = 10 ms sinusoidal		50	А
PARM	Repetitive peak avalanche power $t_p = 10 \ \mu s, T_j = 125 \ ^{\circ}C$		65	W
T _{stg}	Storage temperature range	-65 to +175	°C	
Tj	Operating junction temperature range ⁽¹⁾ -40 to +175			C

Notes:

 $^{(1)}(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table	3:	Thermal	parameters	

Symbol	Parameter	Max. value	Unit
R _{th} (j-l)	Junction to lead	20	°C/W

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
IR ⁽¹⁾ Reverse leakage current		T _j = 25 °C		-		35	μA
IR	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C	$V_R = V_{RRM}$	-	6	10	mA
VF ⁽²⁾	Forward valtage drap	T _j = 25 °C		-		0.63	V
V _F ⁽²⁾ Forward voltage drop		T _j = 125 °C	I _F = 2 A	-	0.50	0.61	V

 Table 4: Static electrical characteristics

Notes:

 $^{(1)}$ Pulse test: tp = 5 ms, δ < 2% $^{(2)}$ Pulse test: tp = 380 µs, δ < 2%

To evaluate the conduction losses, use the following equation:

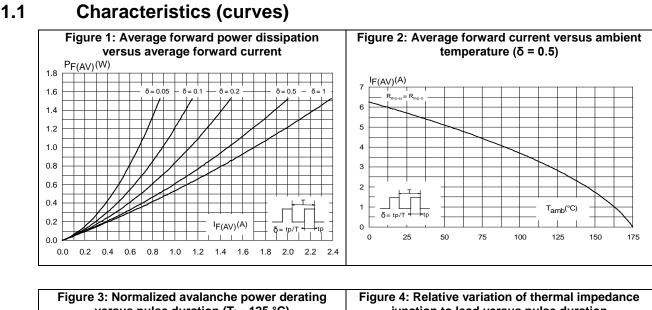
 $P = 0.46 \text{ x } I_{F(AV)} + 0.075 \text{ x } I_{F^{2}(RMS)}$

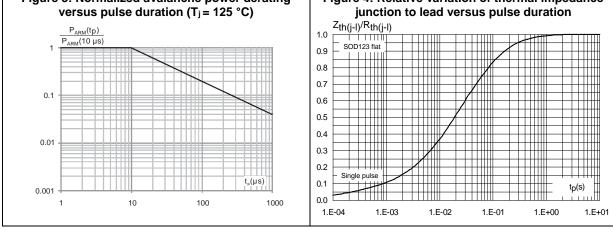
For more information, please refer to the following application notes related to the power losses.

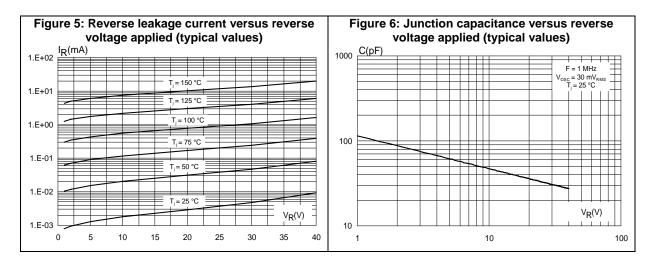
- AN604 (Calculation of conduction losses in a power rectifier)
- AN4021 (Calculation of reverse losses in a power diode)



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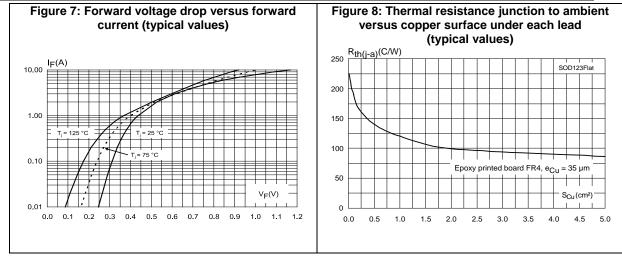




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Characteristics

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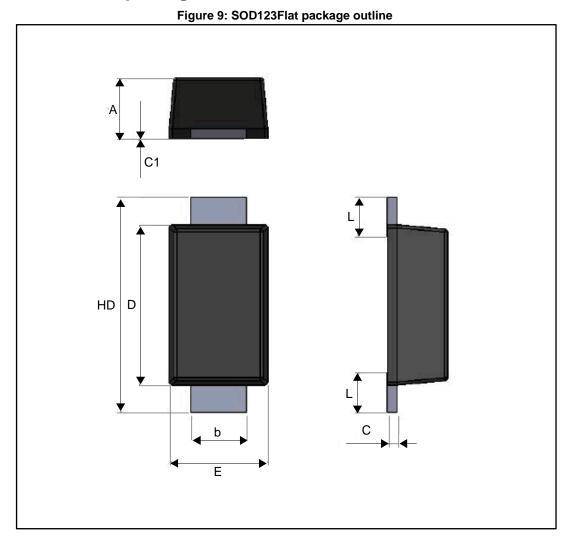
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2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

2.1 SOD123Flat package information



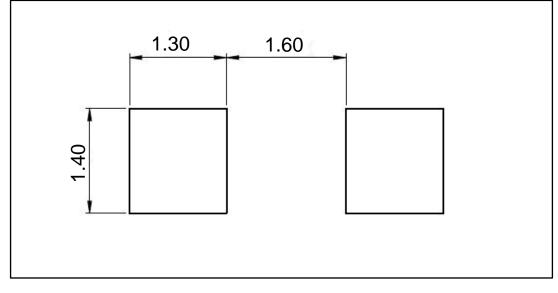
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Package information

STPS2L40ZFY

	Table 5: SOD123Flat package mechanical data				
		Dimensions			
Ref.		Millimeters			
	Min.	Тур.	Max.		
A	0.86	0.98	1.10		
b	0.80	0.90	1.00		
с	0.08	0.15	0.25		
c1	0.00		0.10		
D	2.50	2.60	2.70		
E	1.50	1.60	1.80		
HD	3.30	3.50	3.70		
L	0.45	0.65	0.85		







3 Ordering information

Table 6: Ordering information					
Order code Marking Package Weight Base qty. Delivery mode					
STPS2L40ZFY	2Y4	SOD123Flat	12.5 mg	3000	Tape and reel

4 Revision history

Date	Revision	Changes
13-Oct-2016	1	Initial release.



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